



NOTES:

1. SSH-LXH3121 HOLDER, BLACK NYLON 94-V.
2. SSL-LX3044YGW LED, LEADS CUT TO 5mm.
3. YELLOW ANODE: LXP-WST26R0T0C, RED INSULATED LEAD, 26 AWG, CUT 158mm LONG, STRIP 3.0mm & 6.0mm.
4. GREEN ANODE: LXP-WST26B1T0C, BLACK INSULATED LEAD, 26 AWG, CUT 158mm LONG, STRIP 3.0mm & 6.0mm.
5. MOUNTING HOLE:  $\phi 0.170'' - \phi 0.174''$

ELECTRO-OPTICAL CHARACTERISTICS  $T_A=25^\circ\text{C}$   $I_f=20\text{mA}$

PARAMETER	MIN	TYP	MAX	UNITS	TEST COND
PEAK WAVELENGTH		585 (YELLOW)		nm	
		565 (GREEN)		nm	
FORWARD VOLTAGE (Y/G)		2.1/2.5	2.5/2.6	V <sub>f</sub>	
REVERSE VOLTAGE	5.0			V <sub>r</sub>	I <sub>r</sub> =100 $\mu$ A
AXIAL INTENSITY		30		mcd	I <sub>f</sub> =20mA
VIEWING ANGLE		60		2x theta	
EMITTED COLOR:	YELLOW/GREEN				
EPOXY LENS FINISH:	MILKY WHITE DIFFUSED				

LIMITS OF SAFE OPERATION AT 25°C

PARAMETER	COLORS	MAX	UNITS
PEAK FORWARD CURRENT*		150	mA
STEADY CURRENT	(Y/G)	30/25	mA
POWER DISSIPATION		105	mW
DERATE FROM 25°C		-1.6	mW/°C
OPERATING, STORAGE TEMP.		-40 TO +85	°C
SOLDERING TEMP.		+260	°C
2.0mm FROM BODY			3 SEC. MAX

\* t < 10 $\mu$ S

\*UNLESS OTHERWISE SPECIFIED TOLERANCES PER DECIMAL PRECISION ARE: X=±1 (±0.039), X.X=±0.5 (±0.020), X.XX=±0.25 (±0.010), X.XXX=±0.127 (±0.005). LEAD SIZE=±0.05 (±0.002), LEAD LENGTH=±0.75 (±0.030). MIN= <sup>+0.00</sup> -0.00 DECIMAL PRECISION MAX= <sup>+0.00</sup> -0.00 DECIMAL PRECISION

REV.

PART NUMBER

SSI-LXH312YGW-150

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T-3mm LED BLACK PANEL INDICATOR WITH 6" WIRE LEADS,  
585nm YELLOW/565nm GREEN BICOLOR LED,  
MILKY WHITE DIFFUSED LENS, 6" WIRE LEADS.

**RELIABILITY NOTE**  
OUR MANY YEARS OF EXPERIENCE DATA ACCUMULATION INDICATE THAT SOLDER HEAT IS A MAJOR CAUSE OF EARLY AND FUTURE FAILURE. PLEASE PAY ATTENTION TO YOUR SOLDERING PROCESS.

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			PAGE: 1 OF 1
			SCALE: N/A